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November 2015

FODM121 Series, FODM124, FODM2701, FODM2705 4-Pin Full Pitch Mini-Flat Package Phototransistor Optocouplers

Features

- More than 5 mm Creepage/Clearance
- Compact 4-Pin Surface Mount Package (2.4 mm Maximum Standoff Height)
- Current Transfer Ratio in Selected Groups:
 - DC Input:
 - FODM121: 50–600%
 - FODM121A: 100–300%
 - FODM121B: 50–150%
 - FODM121C: 100–200%
 - FODM124: 100% MIN
 - FODM2701: 50–300%
 - AC Input:
 - FODM2705: 50–300%
- Safety and Regulatory Approvals:
 - UL1577, 3,750 VAC_{RMS} for 1 Minute
 - DIN-EN/IEC60747-5-5, 565 V Peak Working Insulation Voltage

Applications

- Digital Logic Inputs
- Microprocessor Inputs
- Power Supply Monitor
- Twisted Pair Line Receiver
- Telephone Line Receiver

Description

The FODM121 series, FODM124, and FODM2701 consists of a gallium arsenide infrared emitting diode driving a phototransistor in a compact 4-pin mini-flat package. The lead pitch is 2.54 mm. The FODM2705 consists of two gallium arsenide infrared emitting diodes connected in inverse parallel for AC operation.

Functional Block Diagram



Equivalent Circuit
FODM121, FODM124, FODM2701



Equivalent Circuit
FODM2705
Figure 1. Schematic



Figure 2. Package Outlines

Safety and Insulation Ratings

As per DIN EN/IEC 60747-5-5, this optocoupler is suitable for “safe electrical insulation” only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.

Parameter		Characteristics
Installation Classifications per DIN VDE 0110/1.89 Table 1, For Rated Mains Voltage	< 150 V _{RMS}	I–IV
	< 300 V _{RMS}	I–III
Climatic Classification		40/110/21
Pollution Degree (DIN VDE 0110/1.89)		2
Comparative Tracking Index		175

Symbol	Parameter	Value	Unit
V _{PR}	Input-to-Output Test Voltage, Method A, V _{IORM} × 1.6 = V _{PR} , Type and Sample Test with t _m = 10 s, Partial Discharge < 5 pC	904	V _{peak}
	Input-to-Output Test Voltage, Method B, V _{IORM} × 1.875 = V _{PR} , 100% Production Test with t _m = 1 s, Partial Discharge < 5 pC	1060	V _{peak}
V _{IORM}	Maximum Working Insulation Voltage	565	V _{peak}
V _{IOTM}	Highest Allowable Over-Voltage	6000	V _{peak}
	External Creepage	≥ 5	mm
	External Clearance	≥ 5	mm
DTI	Distance Through Insulation (Insulation Thickness)	≥ 0.4	mm
T _S	Case Temperature ⁽¹⁾	150	°C
I _{S,INPUT}	Input Current ⁽¹⁾	200	mA
P _{S,OUTPUT}	Output Power ⁽¹⁾	300	mW
R _{IO}	Insulation Resistance at T _S , V _{IO} = 500 V ⁽¹⁾	> 10 ⁹	Ω

Note:

1. Safety limit values – maximum values allowed in the event of a failure.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. $T_A = 25^\circ\text{C}$ Unless otherwise specified.

Symbol	Parameter	Value	Unit
TOTAL PACKAGE			
T_{STG}	Storage Temperature	-40 to +125	$^\circ\text{C}$
T_{OPR}	Operating Temperature	-40 to +110	$^\circ\text{C}$
T_J	Junction Temperature	-40 to +125	$^\circ\text{C}$
T_{SOL}	Lead Solder Temperature	260 for 10 sec	$^\circ\text{C}$
EMITTER			
I_F (avg)	Continuous Forward Current	50	mA
I_F (pk)	Peak Forward Current (1 μs pulse, 300 pps.)	1	A
V_R	Reverse Voltage	6	V
P_D	Power Dissipation	70	mW
	Derate linearly (Above 75°C)	1.41	$\text{mW}/^\circ\text{C}$
DETECTOR			
I_C	Continuous Collector Current	80	mA
V_{CEO}	Collector-Emitter Voltage	FODM121 Series, FODM124	80
		FODM2701, FODM2705	40
V_{ECO}	Emitter-Collector Voltage	6	V
P_D	Power Dissipation	150	mW
	Derate linearly (Above 80°C)	3.27	$\text{mW}/^\circ\text{C}$

Electrical Characteristics

$T_A = 25^\circ\text{C}$ unless otherwise specified.

Symbol	Parameter	Device	Test Conditions	Min.	Typ.	Max.	Unit
INDIVIDUAL COMPONENT CHARACTERISTICS							
Emitter							
V_F	Forward Voltage	FODM121 Series, FODM124	$I_F = 10\text{ mA}$	1.0		1.3	V
		FODM2701	$I_F = 5\text{ mA}$			1.4	
		FODM2705	$I_F = \pm 5\text{ mA}$				
I_R	Reverse Current	FODM121 Series, FODM124, FODM2701	$V_R = 5\text{ V}$			5	μA
Detector							
BV_{CEO}	Collector-Emitter Breakdown Voltage	FODM121 Series, FODM124	$I_C = 1\text{ mA}, I_F = 0$	80			V
		FODM2701, FODM2705		40			
BV_{ECO}	Emitter-Collector Breakdown Voltage	All	$I_E = 100\text{ }\mu\text{A}, I_F = 0$	7			V
I_{CEO}	Collector Dark Current	All	$V_{CE} = 40\text{ V}, I_F = 0$			100	nA
C_{CE}	Capacitance	All	$V_{CE} = 0\text{ V}, f = 1\text{ MHz}$		10		pF
TRANSFER CHARACTERISTICS							
CTR	DC Current Transfer Ratio	FODM2701	$I_F = 5\text{ mA}, V_{CE} = 5\text{ V}$	50		300	%
		FODM2705	$I_F = \pm 5\text{ mA}, V_{CE} = 5\text{ V}$	50		300	
		FODM121	$I_F = 5\text{ mA}, V_{CE} = 5\text{ V}$	50		600	
		FODM121A		100		300	
		FODM121B		50		150	
		FODM121C		100		200	
		FODM124	$I_F = 1\text{ mA}, V_{CE} = 0.5\text{ V}$	100		1200	
			$I_F = 0.5\text{ mA}, V_{CE} = 1.5\text{ V}$	50			
	CTR Symmetry	FODM2705	$I_F = \pm 5\text{ mA}, V_{CE} = 5\text{ V}$	0.3		3.0	
$V_{CE(SAT)}$	Saturation Voltage	FODM121 Series	$I_F = 8\text{ mA}, I_C = 2.4\text{ mA}$			0.4	V
		FODM124	$I_F = 1\text{ mA}, I_C = 0.5\text{ mA}$			0.4	
		FODM2701	$I_F = 10\text{ mA}, I_C = 2\text{ mA}$			0.3	
		FODM2705	$I_F = \pm 10\text{ mA}, I_C = 2\text{ mA}$			0.3	
t_r	Rise Time (Non-Saturated)	All	$I_C = 2\text{ mA}, V_{CE} = 5\text{ V}, R_L = 100\text{ }\Omega$		3		μs
t_f	Fall Time (Non-Saturated)	All	$I_C = 2\text{ mA}, V_{CE} = 5\text{ V}, R_L = 100\text{ }\Omega$		3		μs
ISOLATION CHARACTERISTICS							
V_{ISO}	Steady State Isolation Voltage ⁽²⁾	All	1 minute	3750			$V_{AC(RMS)}$

Note:

2. Steady state isolation voltage, V_{ISO} , is an internal device dielectric breakdown rating. For this test, pins 1 and 2 are common, and pins 3 and 4 are common.

Typical Performance Curves

$T_A = 25^\circ\text{C}$ unless otherwise specified.



Fig. 3 Forward Current vs. Forward Voltage



Fig. 4 Collector-Emitter Saturation Voltage vs. Ambient Temperature (FODM121/2701/2705)



Fig. 5 Current Transfer Ratio vs. Forward Current (FODM121/2701/2705)



Fig. 6 Collector Current vs. Forward Current (FODM121/2701/2705)



Fig. 7 Collector Current vs. Ambient Temperature (FODM121/2701/2705)

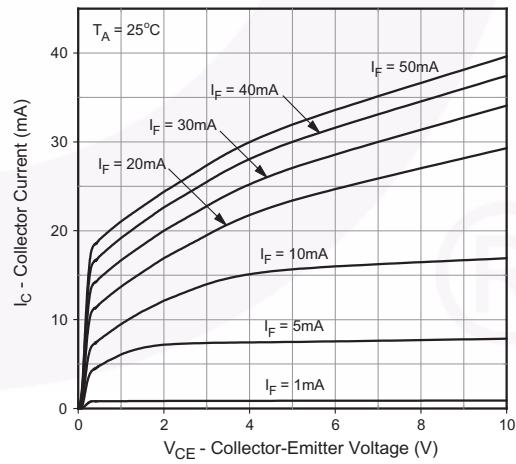


Fig. 8 Collector Current vs. Collector-Emitter Voltage (FODM121/2701/2705)

Typical Performance Curves (Continued)

$T_A = 25^\circ\text{C}$ unless otherwise specified.

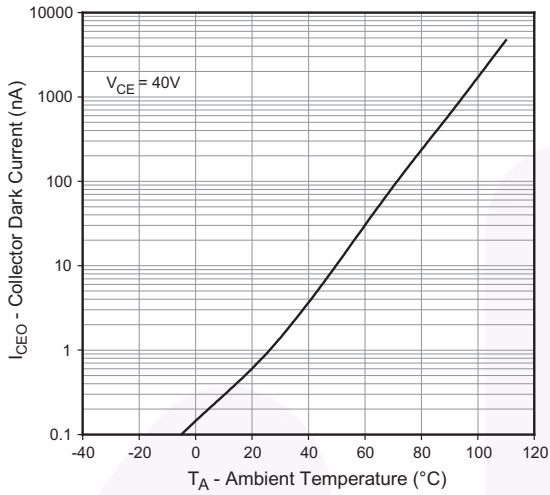


Fig 9. Collector Dark Current vs. Ambient Temperature (FODM121/2701/2705)

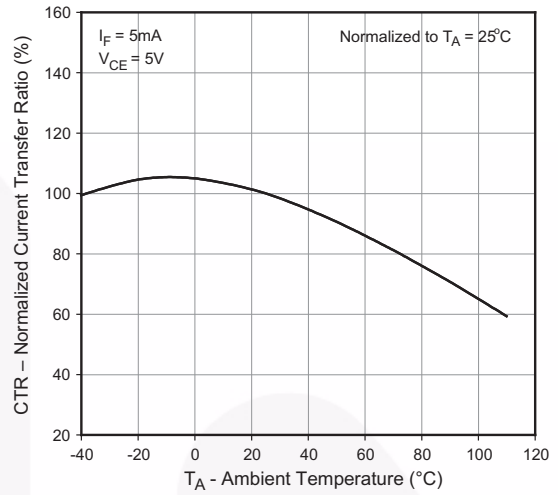


Fig 10. Normalized Current Transfer Ratio vs. Ambient Temperature (FODM121/2701/2705)

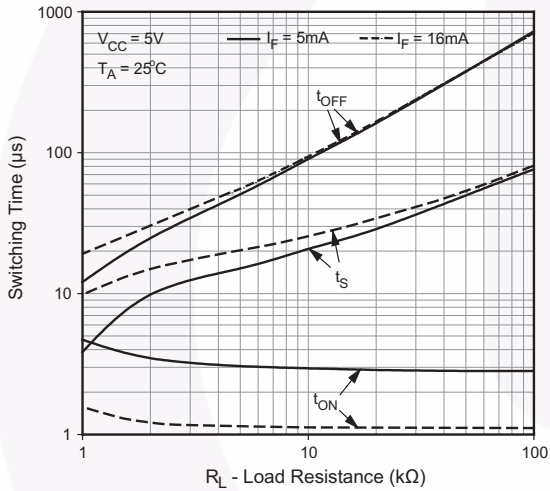


Fig 11. Switching Time vs. Load Resistance (FODM121/2701/2705)



Fig 12. Collector-Emitter Saturation Voltage vs. Ambient Temperature (FODM124)

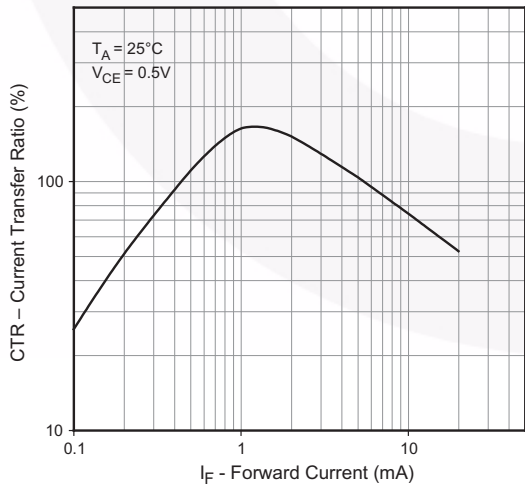


Fig 13. Current Transfer Ratio vs. Forward Current (FODM124)



Fig 14. Collector Current vs. Forward Current (FODM124)

Typical Performance Curves (Continued)

$T_A = 25^\circ\text{C}$ unless otherwise specified.



Fig. 15. Collector Current vs. Ambient Temperature (FODM124)



Fig. 16. Collector Current vs. Collector-Emitter Voltage (FODM124)



Fig. 17. Collector Dark Current vs. Ambient Temperature (FODM124)



Fig. 18. Normalized Current Transfer Ratio vs. Ambient Temperature (FODM124)



Fig. 19. Switching Time vs. Load Resistance (FODM124)

Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmín)	150°C
Temperature Max. (Tsmáx)	200°C
Time (ts) from (Tsmín to Tsmáx)	60–120 seconds
Ramp-up Rate (tL to tp)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (tL) Maintained Above (TL)	60–150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (tp) within 5°C of 260°C	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

Ordering Information

Part Number	Package	Packing Method
FODM121	Full Pitch Mini-Flat 4-Pin	Tube (100 units)
FODM121R2	Full Pitch Mini-Flat 4-Pin	Tape and Reel (2500 Units)
FODM121V	Full Pitch Mini-Flat 4-Pin, DIN EN/IEC60747-5-5 Option	Tube (100 Units)
FODM121R2V	Full Pitch Mini-Flat 4-Pin, DIN EN/IEC60747-5-5 Option	Tape and Reel (2500 Units)

Note:

The product orderable part number system listed in this table also applies to the FODM121A, FODM121B, FODM121C, FODM124, FODM2701, and FODM2705 products.

Marking Information



Figure 20. Top Mark

Table 1. Top Mark Definitions

1	Fairchild Logo
2	Device Number
3	DIN EN/IEC60747-5-5 Option (only appears on component ordered with this option)
4	One-Digit Year Code, e.g., "5"
5	Digit Work Week, Ranging from "01" to "53"
6	Assembly Package Code



NOTES:

- A) NO STANDARD APPLIES TO THIS PACKAGE.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
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- D) DRAWING FILENAME AND REVISION: MKT-MFP04Crev3.



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